Title (en)

Al-Mg-Si based aluminum alloy extrusion

Title (de)

Stranggepresste Al-Mg-Si Legierung auf Aluminium Basis

Title (fr)

Extrusion d'un alliage de Al-Mg-Si à base d'aluminium

Publication

EP 0997547 A1 20000503 (EN)

Application

EP 99120845 A 19991026

Priority

- JP 30561698 A 19981027
- JP 5636899 A 19990304

Abstract (en)

An Al-Mg-Si based aluminum alloy extrusion having large strength, absorbable impact energy and resistance against compressing cracking, wherein the average size of Mg2Si precipitation in the Ä1 0 0Ü and Ä0 1 0Ü directions of the (1 0 0) plane inside grains is 20 nm or more, the distribution density of the Mg2Si precipitation in the Ä0 0 1Ü direction of the (1 0 0) plane is 100 or more per mu m<2>, and the size of precipitations on grain boundaries is 1000 nm or less. Alternatively, in the Al-Mg-Si based aluminum alloy extrusion, a tensile strength obtained from a tensile test performed at a strain rate of 1000 per second is from 150 to 400 N/mm<2> (both inclusive).

IPC 1-7

C22C 21/02; C22C 21/04; C22C 21/06; C22C 21/08; C22F 1/05

IPC 8 full level

C22C 21/02 (2006.01); **C22C 21/08** (2006.01); **C22F 1/05** (2006.01)

CPC (source: EP US)

C22C 21/02 (2013.01 - EP US); **C22C 21/08** (2013.01 - EP US); **C22F 1/05** (2013.01 - EP US)

Citation (search report)

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- [X] PATENT ABSTRACTS OF JAPAN vol. 1995, no. 05 30 June 1995 (1995-06-30)
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- [X] PATENT ABSTRACTS OF JAPAN vol. 1997, no. 01 31 January 1997 (1997-01-31)
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Designated contracting state (EPC)

DE FR GB

DOCDB simple family (publication)

EP 0997547 A1 20000503; US 2002014287 A1 20020207; US 2003041925 A1 20030306

DOCDB simple family (application)

EP 99120845 A 19991026; US 16221302 A 20020605; US 42529799 A 19991025